

FMH20N50ES

FUJI POWER MOSFET

Super FAP-E^{3S} series

N-CHANNEL SILICON POWER MOSFET

Features

Maintains both low power loss and low noise Lower $R_{DS}(on)$ characteristic More controllable switching dv/dt by gate resistance Smaller V_{GS} ringing waveform during switching Narrow band of the gate threshold voltage (4.2±0.5V) High avalanche durability

Applications

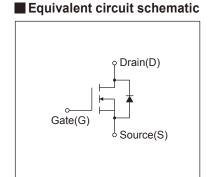
Switching regulators UPS (Uninterruptible Power Supply) DC-DC converters

■ Maximum Ratings and Characteristics

● Absolute Maximum Ratings at Tc=25°C (unless otherwise specified)

TO-3P (Q) 15.5mm 53.2 db.1 158.2 10 0.2 10 158.2	4.5 th.2 97.2 th.2 15.1.3 th.2
+ + + • • •	CONNECTION ① BASE ② COLLECTOR ③ DMITTER EIAJ: SC-65

■ Outline Drawings [mm]



Description	Symbol	Characteristics	Unit	Remarks	
Dunin Commo Voltano	V _{DS}	500	V		
Drain-Source Voltage	V _{DSX}	500	V	V _{GS} = -30V	
Continuous Drain Current	I _D	±20	А		
Pulsed Drain Current	IDP	±80	А		
Gate-Source Voltage	V _{GS}	±30	V		
Repetitive and Non-Repetitive Maximum Avalanche Current	Iar	20	А	Note*1	
Non-Repetitive Maximum Avalanche Energy	Eas	582.5	mJ	Note*2	
Repetitive Maximum Avalanche Energy	Ear	23.5	mJ	Note*3	
Peak Diode Recovery dV/dt	dV/dt	4.6	kV/μs	Note*4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note*5	
Maximum Power Dissipation	Po	2.50	14/	Ta=25°C	
		235	W	Tc=25°C	
Operating and Storage Temperature range	Tch	150	°C		
	Tsto	-55 to + 150	°C		

● Electrical Characteristics at Tc=25°C (unless otherwise specified)

Description	Symbol	Conditions		min.	typ.	max.	Unit	
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250µA, V _{GS} =0V		500	-	-	V	
Gate Threshold Voltage	V _{GS} (th)	In=250µA, Vns=Vgs	I _D =250μA, V _{DS} =V _{GS}		4.2	4.7	V	
Zero Gate Voltage Drain Current	Ipss	V _{DS} =500V, V _{GS} =0V	T _{ch} =25°C	-	-	25		
	IDSS	V _{DS} =400V, V _{GS} =0V	T _{ch} =125°C	-	-	250	μA	
Gate-Source Leakage Current	Igss	V _{GS} =±30V, V _{DS} =0V	V _{GS} =±30V, V _{DS} =0V		10	100	nA	
Drain-Source On-State Resistance	R _{DS} (on)	I _D =10A, V _{GS} =10V		-	0.27	0.31	Ω	
Forward Transconductance	g _{fs}	I _D =10A, V _{DS} =25V		5	10	-	S	
Input Capacitance	Ciss	V _{DS} =25V V _{GS} =0V f=1MHz		-	2100	3150	pF	
Output Capacitance	Coss			-	250	375		
Reverse Transfer Capacitance	Crss			-	15	22.5		
Turn-On Time	td(on)	V_{cc} =300V V_{ds} =10V I_{D} =10A R_{cs} =15 Ω		-	40	60	ns	
Turn-On Time	tr			-	38	57		
Turn-Off Time	td(off)			-	85	127.5		
	tf			-	17	25.5		
Total Gate Charge	Q _G	\/ 050\/			57	85.5	nC	
Gate-Source Charge	Qgs	V _{cc} =250V I _D =20A V _{GS} =10V		-	21	31.5		
Gate-Drain Charge	Q _{GD}			-	21	31.5		
Gate-Drain Crossover Charge	Qsw			-	10	15		
Avalanche Capability	lav	L=1.07mH, Tch=25°C	L=1.07mH, Tch=25°C		-	-	Α	
Diode Forward On-Voltage	V _{SD}	I _F =20A, V _{GS} =0V, T _{ch} =25°C		-	0.90	1.35	V	
Reverse Recovery Time	trr	I _F =20A, V _{GS} =0V		-	0.5	-	μs	
Reverse Recovery Charge	Qrr	-di/dt=100A/µs, Tch=25°C		-	7.0	-	μC	

Thermal Characteristics

Description	Symbol	Test Conditions	min.	typ.	max.	Unit
Thermal resistance	Rth (ch-c)	Channel to Case			0.530	°C/W
	Rth (ch-a)	Channel to Ambient			50.0	°C/W

Note *1 : Tch≤150°C

Note *2 : Stating Tch=25°C, I_{AS}=8A, L=16.7mH, Vcc=50V, R_G=50Ω.

EAS limited by maximum channel temperature and avalanche current.

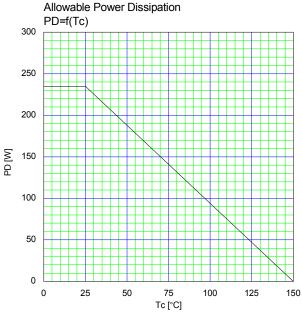
See to 'Avalanche Energy' graph.

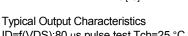
Note *3 : Repetitive rating : Pulse width limited by maximum channel temperature.

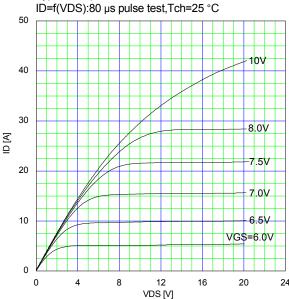
See to the 'Transient Themal impeadance' graph.

Note *4 : Ir≤-Iɒ, -di/dt=100A/µs, Vcc≤BVɒss, Tch≤150°C.

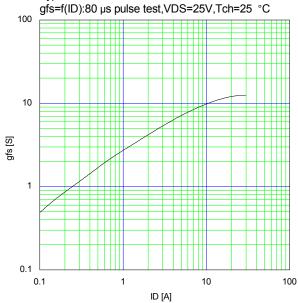
Note *5 : Ir≤-Iɒ, dv/dt=4.6kV/µs, Vcc≤BVɒss, Tch≤150°C.

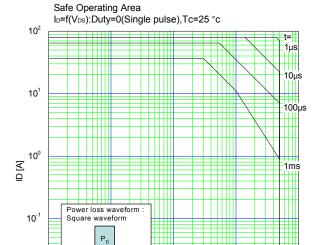






Typical Transconductance





Typical Transfer Characteristic ID=f(VGS):80 μs pulse test,VDS=25V,Tch=25 °C

10¹ VDS [V]

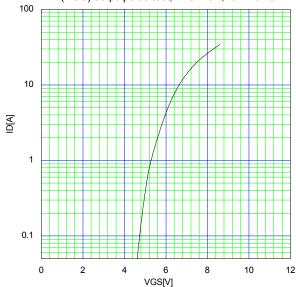
10°

10²

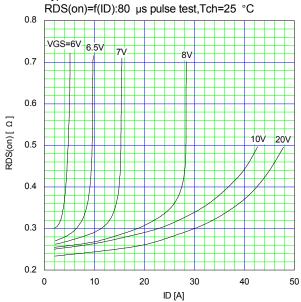
10³

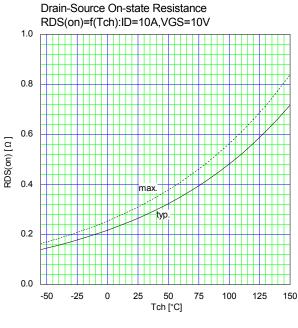
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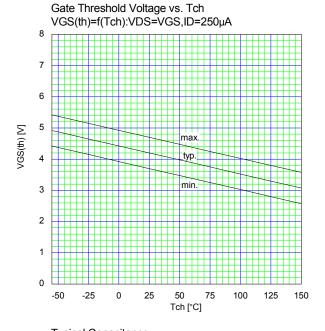
10⁻¹

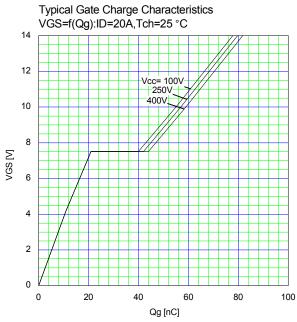


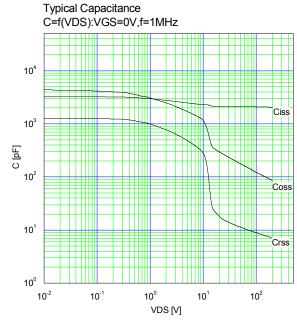
Typical Drain-Source on-state Resistance

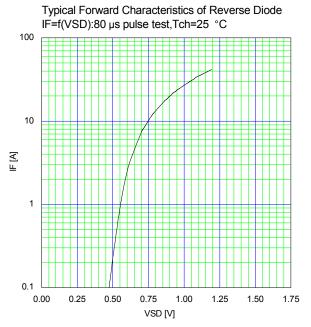


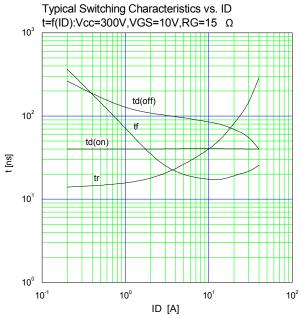


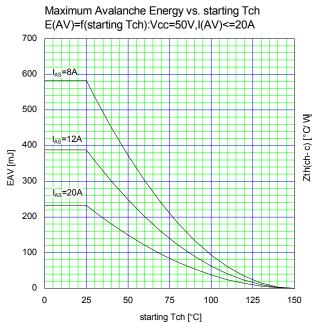


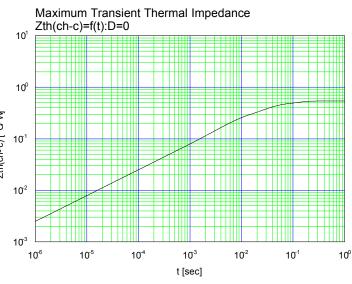












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